WNSC2D051400D



#### Silicon Carbide Diode Rev.01 - 12 October 2022

**Product data sheet** 

### **1. General description**

Silicon Carbide Schottky diode in a TO252 (DPAK) plastic package, designed for high frequency switched-mode power supplies.



### 2. Features and benefits

- Highly stable switching performance
  - High forward surge capability I<sub>FSM</sub>
- · Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T<sub>j(max)</sub> = 175 °C)

### 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

### 4. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
$V_{RRM}$	repetitive peak reverse voltage				1400		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 153 °C; Fig. 1; Fig. 2; Fig. 3		5		A	
T <sub>j</sub>	junction temperature			175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.49	1.70	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	2.15	2.60	V
Dynamic	characteristics				1	1	
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 5 A; dI <sub>F</sub> /dt = 500 A/μs; V <sub>R</sub> = 400 V; T <sub>i</sub> = 25 °C; <u>Fig. 7</u>		-	10	-	nC

# **5. Pinning information**

Table 2.	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected		к _ [1]_ А
2	К	cathode [1]		K <u>– A</u> 001aaa020
3	А	anode		
mb	К	mounting base; connected to cathode		

[1] It is not possible to connect to pin 2 of the TO252 package.

# 6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC2D051400D	TO252	WNSC2D051400D6J	Reel	2500	TO252NS	14-Nov-2016		

### 7. Marking

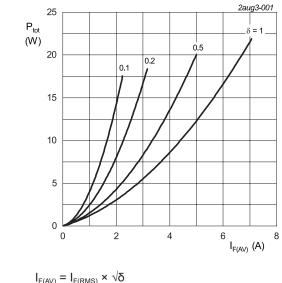
Table 4. Marking codes	
Type number	Marking codes
WNSC2D051400D	WNSC2D 05140D

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage			1400	V
V <sub>RWM</sub>	crest working reverse voltage			1400	V
V <sub>R</sub>	reverse voltage	DC		1400	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 153 °C; Fig. 1; Fig. 2; Fig. 3		5	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 153 °C; square-wave pulse		10	A
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		45	А
	forward current	$t_p$ = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		450	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	sine-wave pulse; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 10 ms		10.125	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-55 to 175	°C
Tj	junction temperature			-55 to 175	°C



$$\begin{split} I_{F(AV)} &= I_{F(RMS)} \times \sqrt{\delta} \\ V_o &= 0.905 \; V; \; R_s = 0.3102 \; \Omega \end{split}$$
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

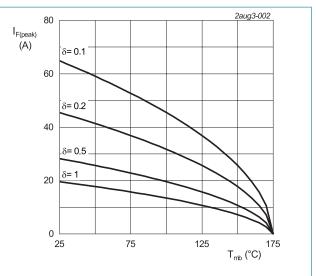
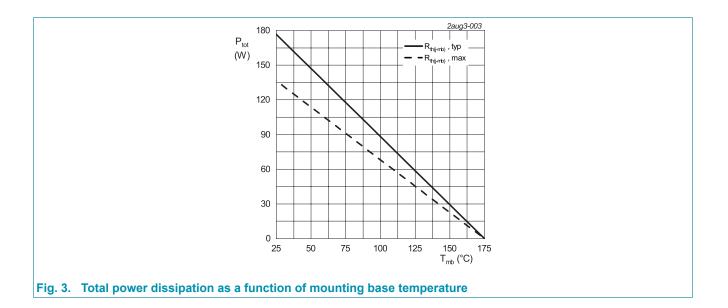


Fig. 2. Current derating as a function of mounting base temperature

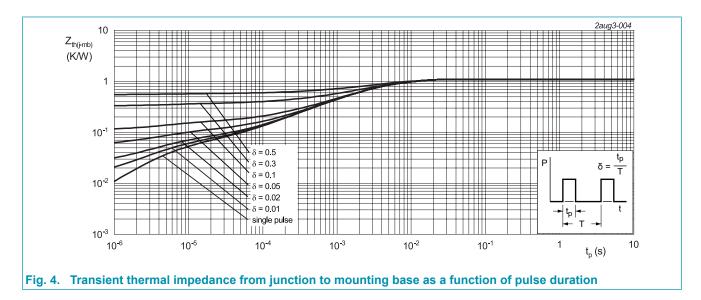
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### WNSC2D051400D Silicon Carbide Diode



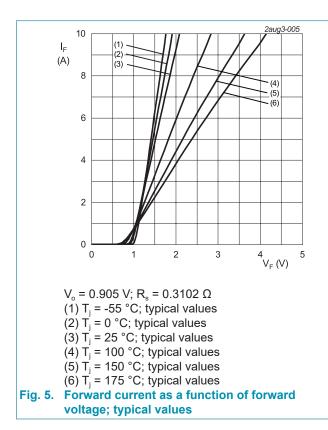
### 9. Thermal characteristics

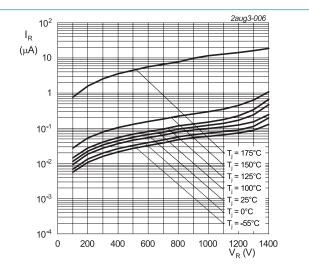
Table 6. Th	Table 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	0.85	1.1	K/W	
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W	



### **10. Characteristics**

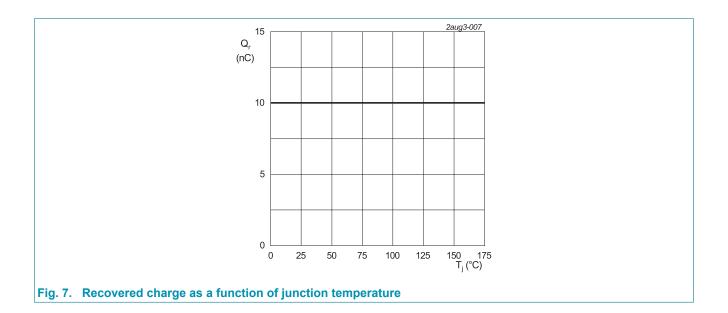
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
	aracteristics						
V <sub>F</sub>	forward current	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.49	1.70	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	2.15	2.60	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.40	2.80	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1400 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	0.5	25	μA
		V <sub>R</sub> = 1400 V; T <sub>j</sub> = 175 °C; <u>Fig. 6</u>		-	25	-	μA
Dynamic	characteristics						
Qr	recovered charge	I <sub>F</sub> = 5 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 500 A/μs; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		-	10	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C		-	220	-	pF
		f = 1 MHz; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C		-	20	-	pF
		f = 1 MHz; V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C		-	17	-	pF
E <sub>as</sub>	non-repetitive avalanche energy	$I_R = 4.3 \text{ A}; \text{ L} = 10 \text{ mH}; \text{ T}_{j(init)} = 25 \text{ °C}$		90	-	-	mJ



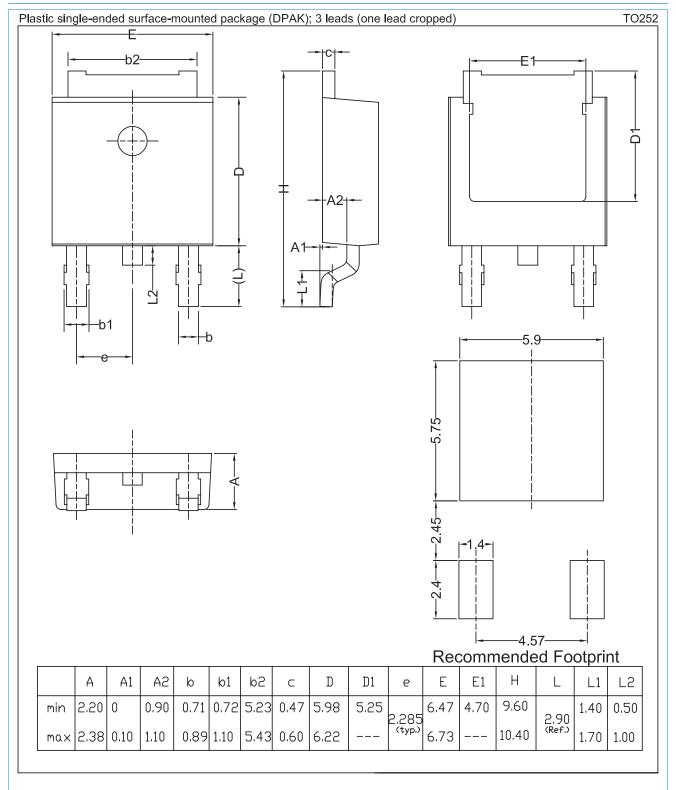




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### **11. Package outline**



WNSC2D051400D
Product data sheet

# WNSC2D051400D

#### Silicon Carbide Diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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# WNSC2D051400D

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